

# SANYO Semiconductors

DATA SHEET

An ON Semiconductor Company

# MCH3478-

# N-Channel Silicon MOSFET General-Purpose Switching Device Applications

· Ultrahigh speed switching

· Halogen free compliance

# Features

- Low ON-resistance
- 1.8V drive
- Protection diode in

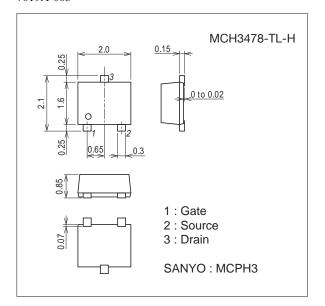
# **Specifications**

#### Absolute Maximum Ratings at Ta=25°C

5				
Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	VDSS		30	V
Gate-to-Source Voltage	VGSS		±12	V
Drain Current (DC)	ID		2	А
Drain Current (PW≤10s)	ID	Duty cycle≤1%	2.5	А
Drain Current (Pulse)	IDP	PW⊴10µs, duty cycle≤1%	8	А
Allowable Power Dissipation	PD	When mounted on ceramic substrate (900mm <sup>2</sup> ×0.8mm)	0.8	W
		When mounted on ceramic substrate (900mm <sup>2</sup> ×0.8mm), PW=10s	1.2	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		–55 to +150	°C

#### Package Dimensions

unit : mm (typ) 7019A-003



#### Product & Package Information

• Package : MCPH3

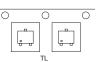
• JEITA, JEDEC

: SC-70, SOT-323

• Minimum Packing Quantity : 3,000 pcs./reel

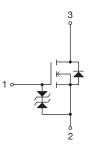
#### Packing Type : TL

#### Marking





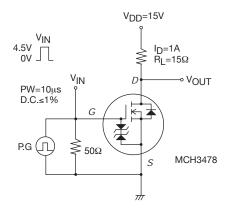
#### **Electrical Connection**



Electrical	<b>Characteristics</b> at Ta=25°C	
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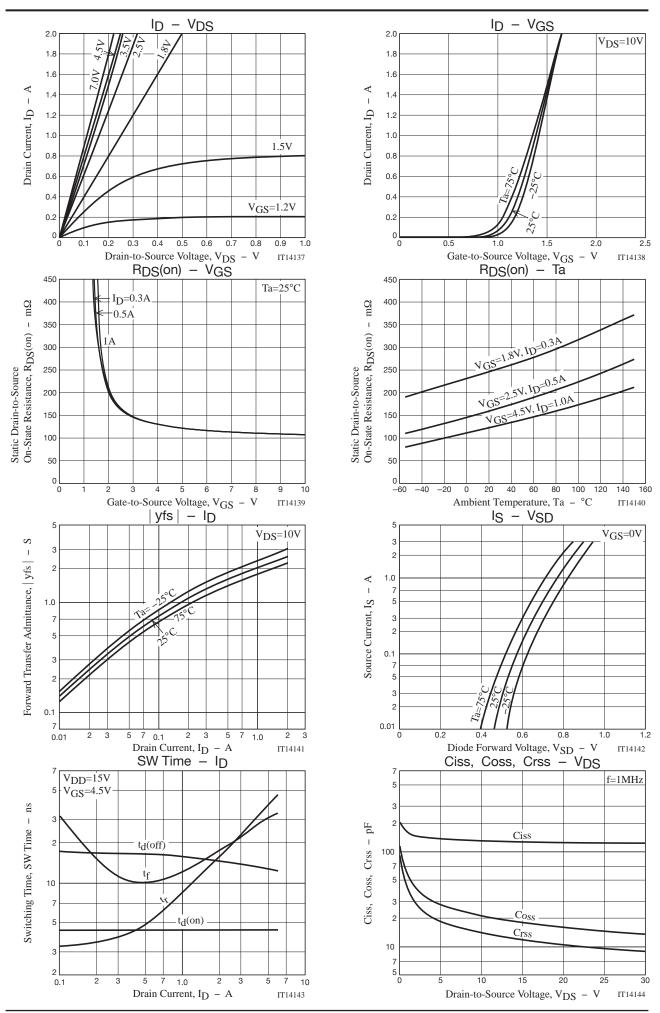
Parameter	Cumbal	Conditions	Ratings			1.134	
Parameter	Symbol	Conditions	min	typ	max	Unit	
Drain-to-Source Breakdown Voltage	V(BR)DSS	ID=1mA, VGS=0V	30			V	
Zero-Gate Voltage Drain Current	IDSS	V <sub>DS</sub> =30V, V <sub>GS</sub> =0V			1	μA	
Gate-to-Source Leakage Current	IGSS	V <sub>GS</sub> =±8V, V <sub>DS</sub> =0V			±10	μΑ	
Cutoff Voltage	V <sub>GS</sub> (off)	V <sub>DS</sub> =10V, I <sub>D</sub> =1mA	0.4		1.3	V	
Forward Transfer Admittance	yfs	V <sub>DS</sub> =10V, I <sub>D</sub> =1A	1.2	2.0		S	
Static Drain-to-Source On-State Resistance	R <sub>DS</sub> (on)1	ID=1A, VGS=4.5V		125	165	mΩ	
	R <sub>DS</sub> (on)2	ID=0.5A, VGS=2.5V		165	235	mΩ	
	R <sub>DS</sub> (on)3	ID=0.3A, VGS=1.8V		250	375	mΩ	
Input Capacitance	Ciss			130		pF	
Output Capacitance	Coss	VDS=10V, f=1MHz		21		pF	
Reverse Transfer Capacitance	Crss			14		pF	
Turn-ON Delay Time	t <sub>d</sub> (on)			4.4		ns	
Rise Time	tr			8.7		ns	
Turn-OFF Delay Time	t <sub>d</sub> (off)	See specified Test Circuit.		16		ns	
Fall Time	tf	-		12		ns	
Total Gate Charge	Qg			1.7		nC	
Gate-to-Source Charge	Qgs	V <sub>DS</sub> =10V, V <sub>GS</sub> =4.5V, I <sub>D</sub> =2A		0.25		nC	
Gate-to-Drain "Miller" Charge	Qgd	1		0.38		nC	
Diode Forward Voltage	VSD	IS=2A, VGS=0V		0.85	1.2	V	

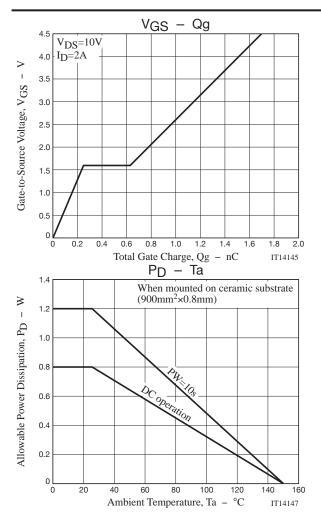
# Switching Time Test Circuit

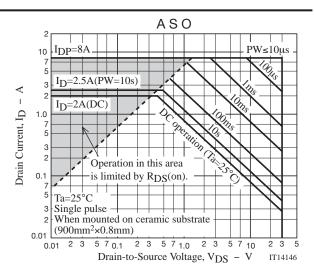


## **Ordering Information**

Device	Package	Shipping	memo	
MCH3478-TL-H	MCPH3	3,000pcs./reel	Pb Free and Halogen Free	







## Taping Specification MCH3478-TL-H

1. Packing Format

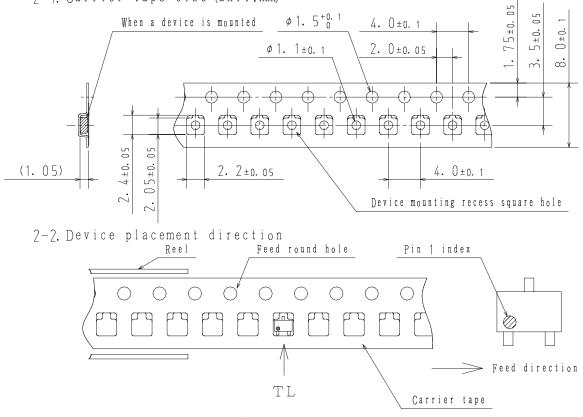
Package Name Carrier	r Tape Maximun Number of devices contained (pcs)			Packing format		
Тур	e Reel	Inner box	Outer box	Inner BOX (C-1) Outer BOX (A-7)		
МСРНЗ МСР	'H 3 3,000	) 15,000	90,000	J 5 reels contained 6 inner boxes contained		
				Dimensions:mm (external) Dimensions:mm (external)		
				183×72×185 440×195×210		
Reel label, Inner box labelQuter box label						
Packing method (unit:mm) It is a label at the time of factory ship The form of a label may change in physica distribution process.						
0		<	6	<u>69</u> <u>108</u>		
Ree	-> (1) -> (2) -> AS NOTE	11 11111 111111 111111 17 107 0,00 111111 111111 111111 SPECIAL 111111 111111 111111 * 20722( SSEEMBLY:*****( (1) e LEAD F]	POOOOOOO TYPE CODE IIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIII			

LEAD FREE 4

JEITA Phase 3

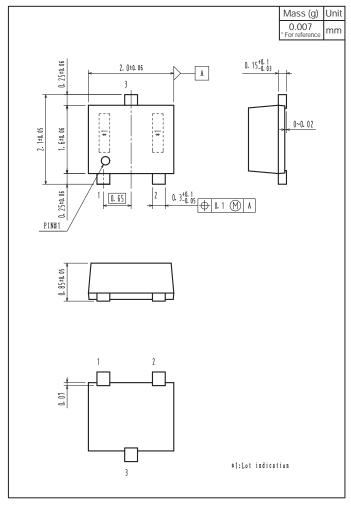
2. Taping configuration

2-1. Carrier tape size (unit:mm)

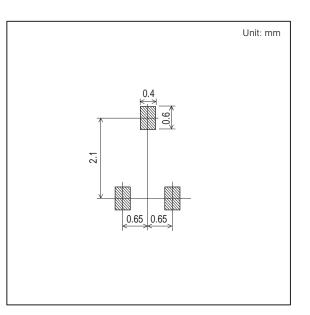


Those with pin 1 index on the feed hole side  $\cdots \cdots TL$ 

# Outline Drawing MCH3478-TL-H



# Land Pattern Example



Note on usage : Since the MCH3478 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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